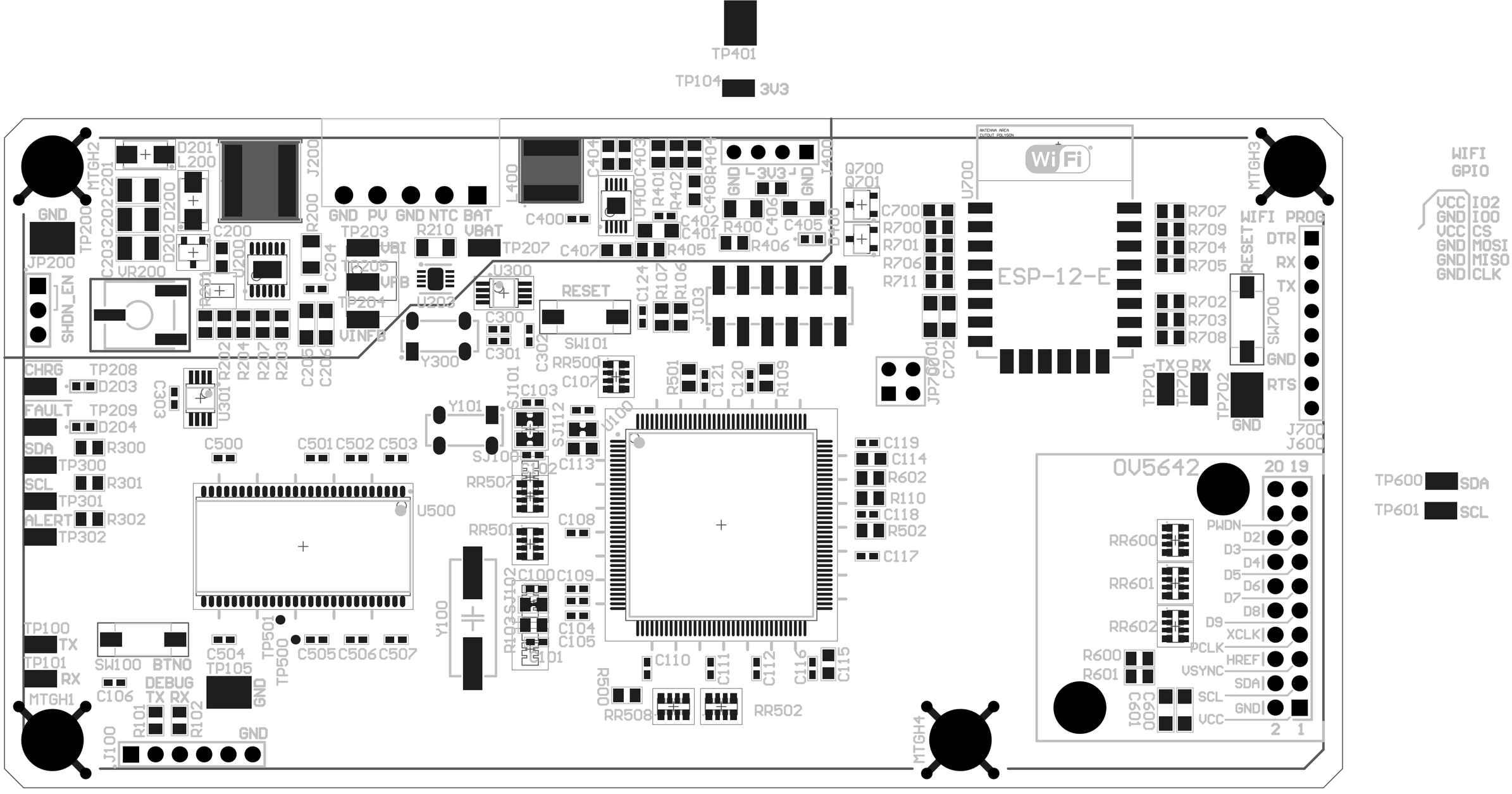
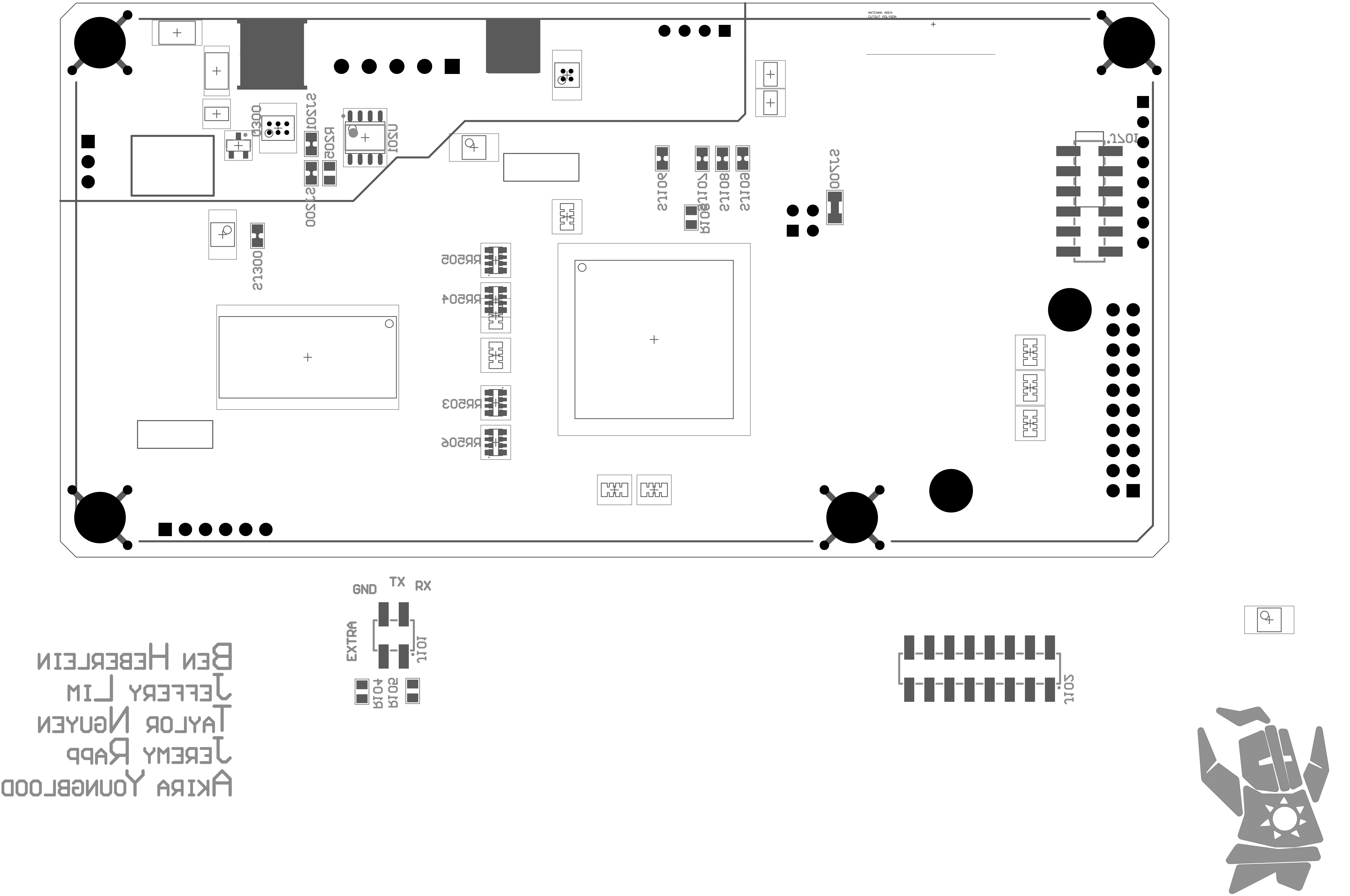
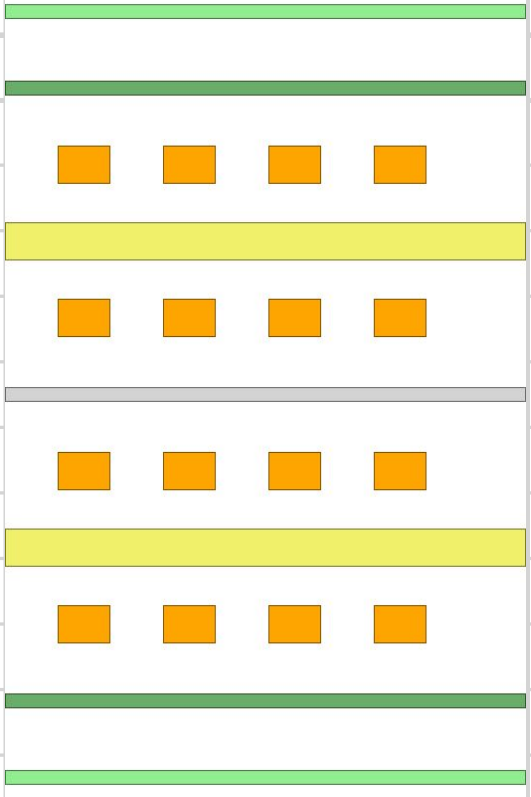
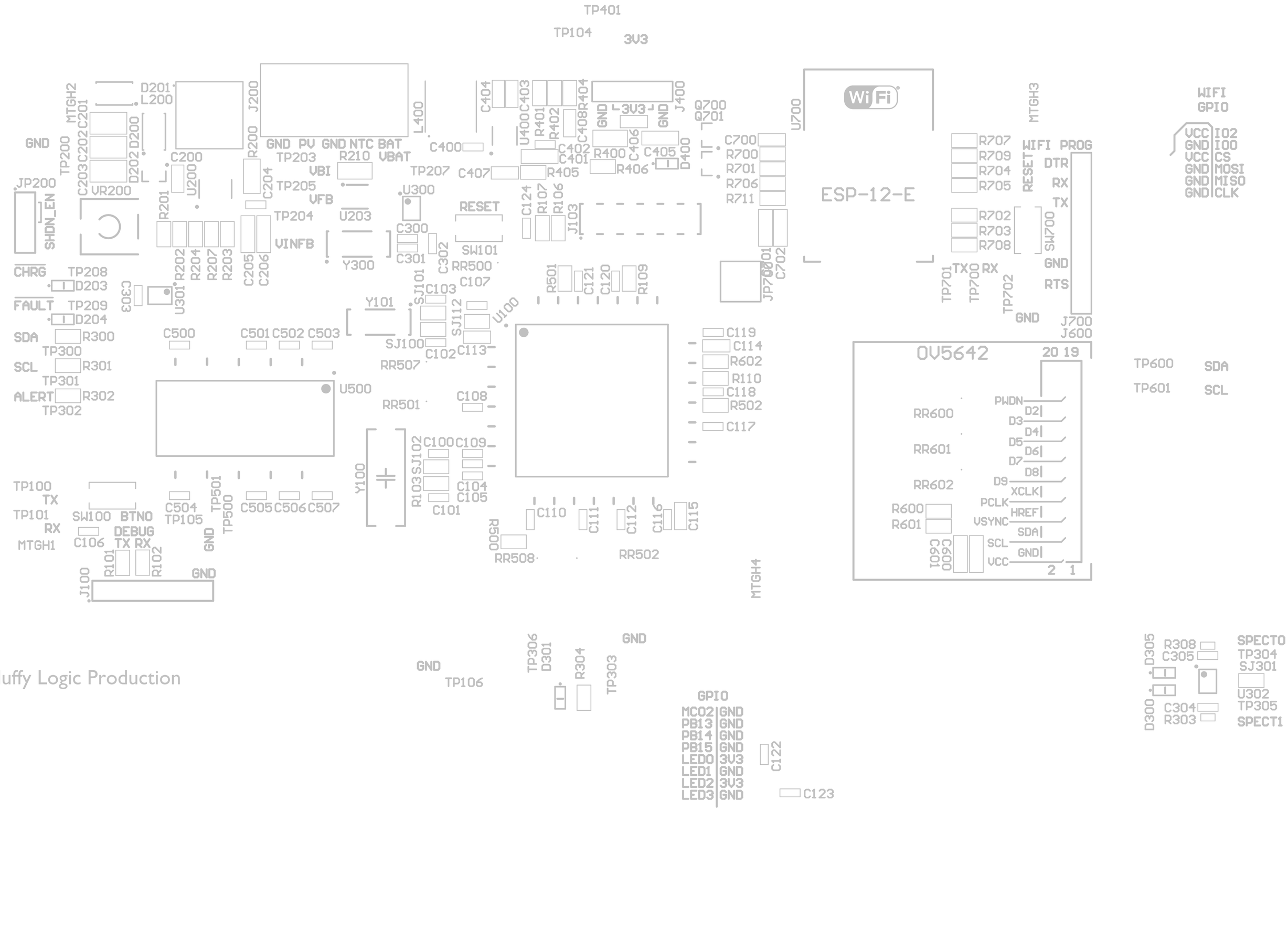


A Fluffy Logic Production


ANTENNA AREA
CUTOUT POLYGON
S1201
R205
S1200
Q300
U201
S1300
RR505
RR504
RR503
RR506
S1106
S1107
S1108
S1109
R108
S1700
J1701
GND
TX
RX
EXTRA
J101
R104
R105
J102
Ben Heberlein
Jeffery Lim
Taylor Nguyen
Jeremy Rapp
Akira Youngblood

Board Stack Report

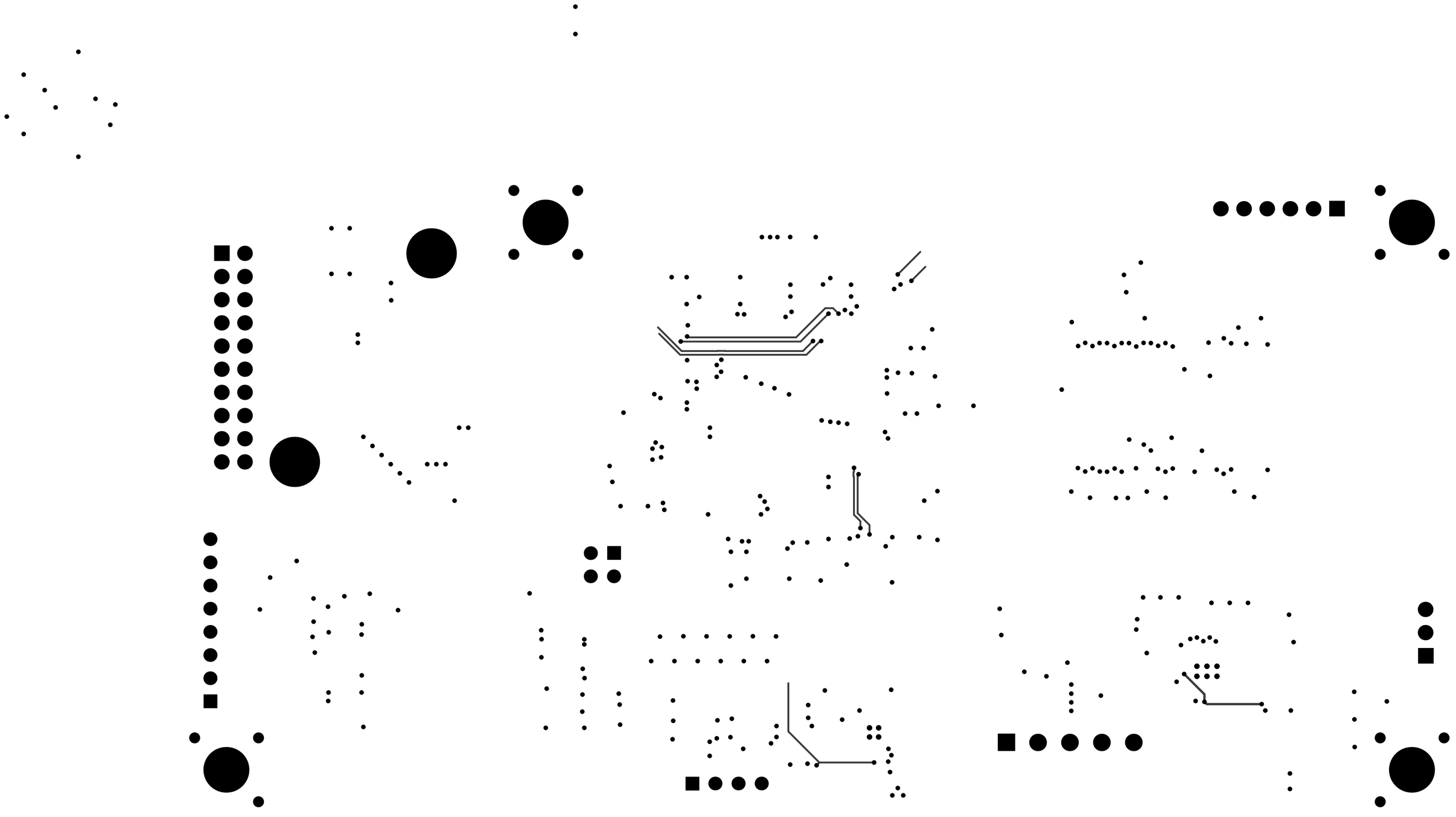
Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1		Top Paste			
2		Top Overlay			
3		Top Solder	Solder Resist	0.40mil	3.5
4		Top Layer	Copper	1.37mil	
5		Dielectric 1	2x2116	9.80mil	4.2
6		Signal Layer 2	Copper	1.37mil	
7		Dielectric 4		40.00mil	4.2
8		Signal Layer 1	Copper	1.37mil	
9		Dielectric 3	2x2116	9.80mil	4.2
10		Bottom Layer	Copper	1.37mil	
11		Bottom Solder	Solder Resist	0.40mil	3.5
12		Bottom Overlay			
13		Bottom Paste			
	Height : 65.88mil				

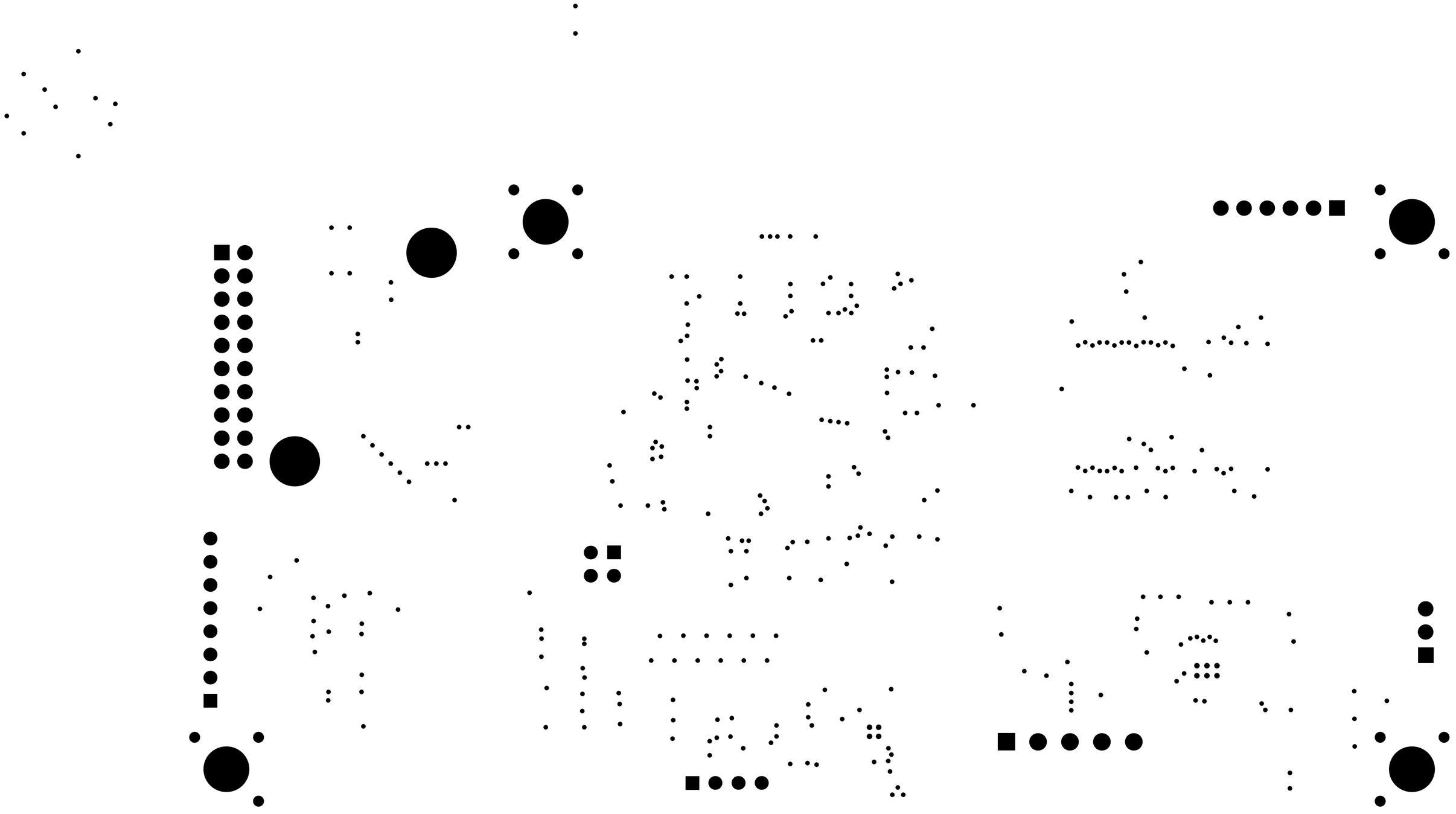


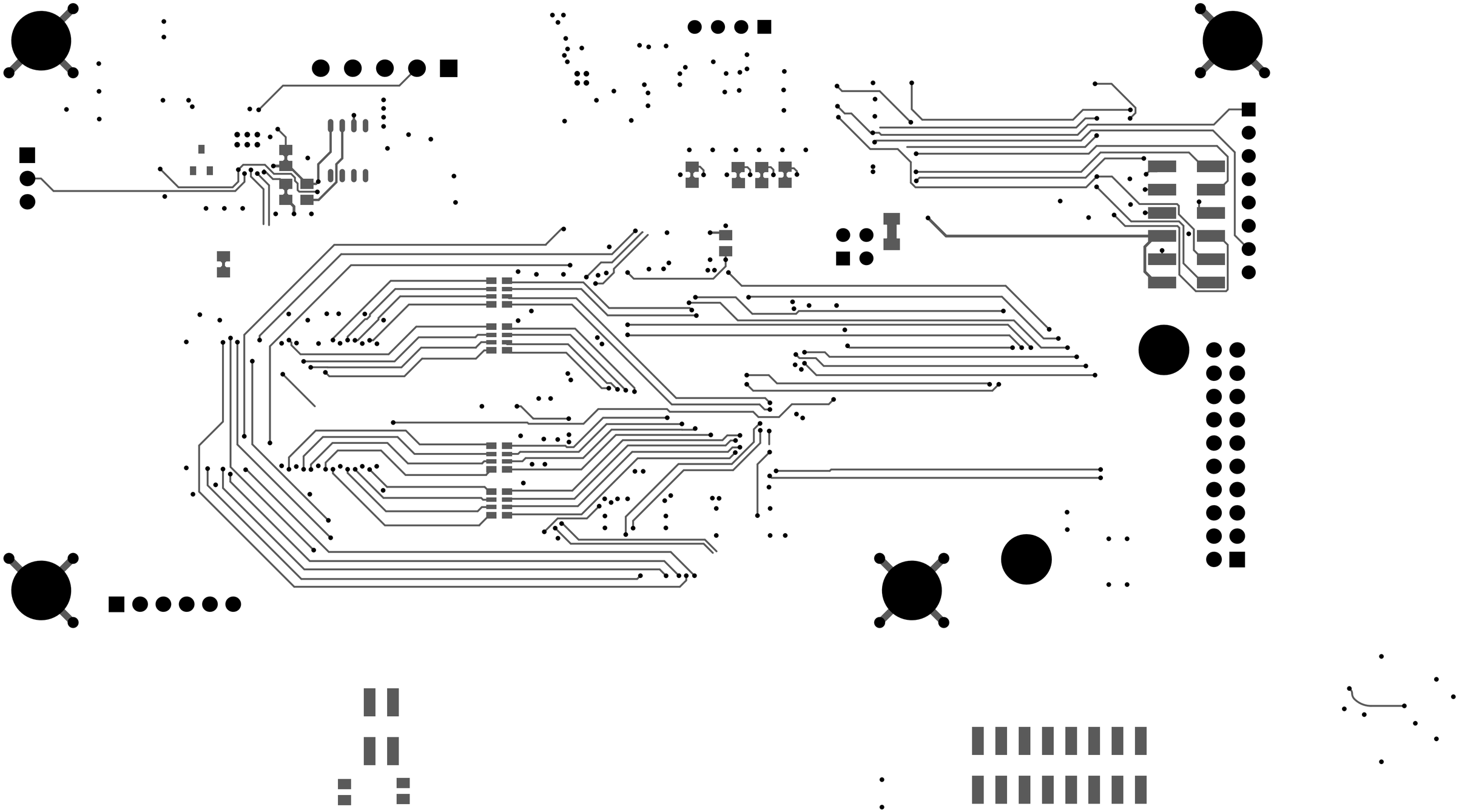
A Fluffy Logic Production

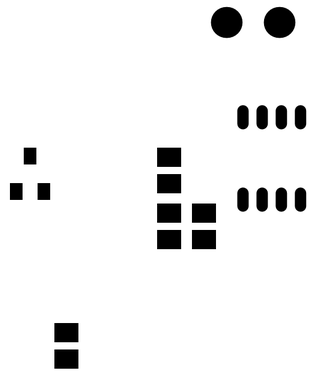
SOLENS

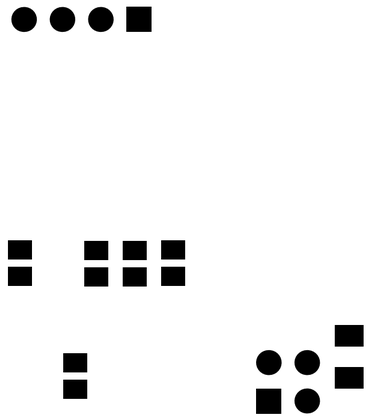
SOLENS

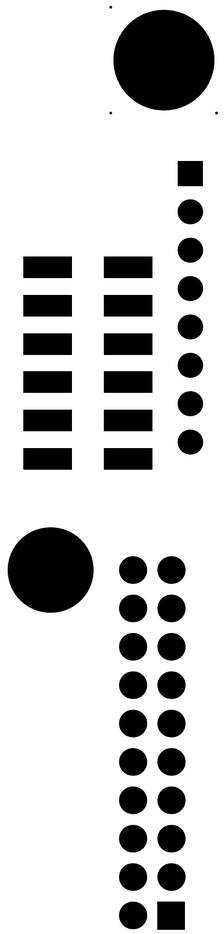


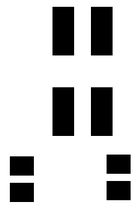


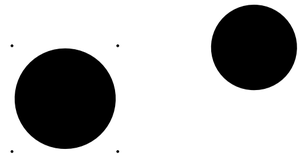


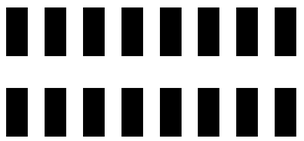


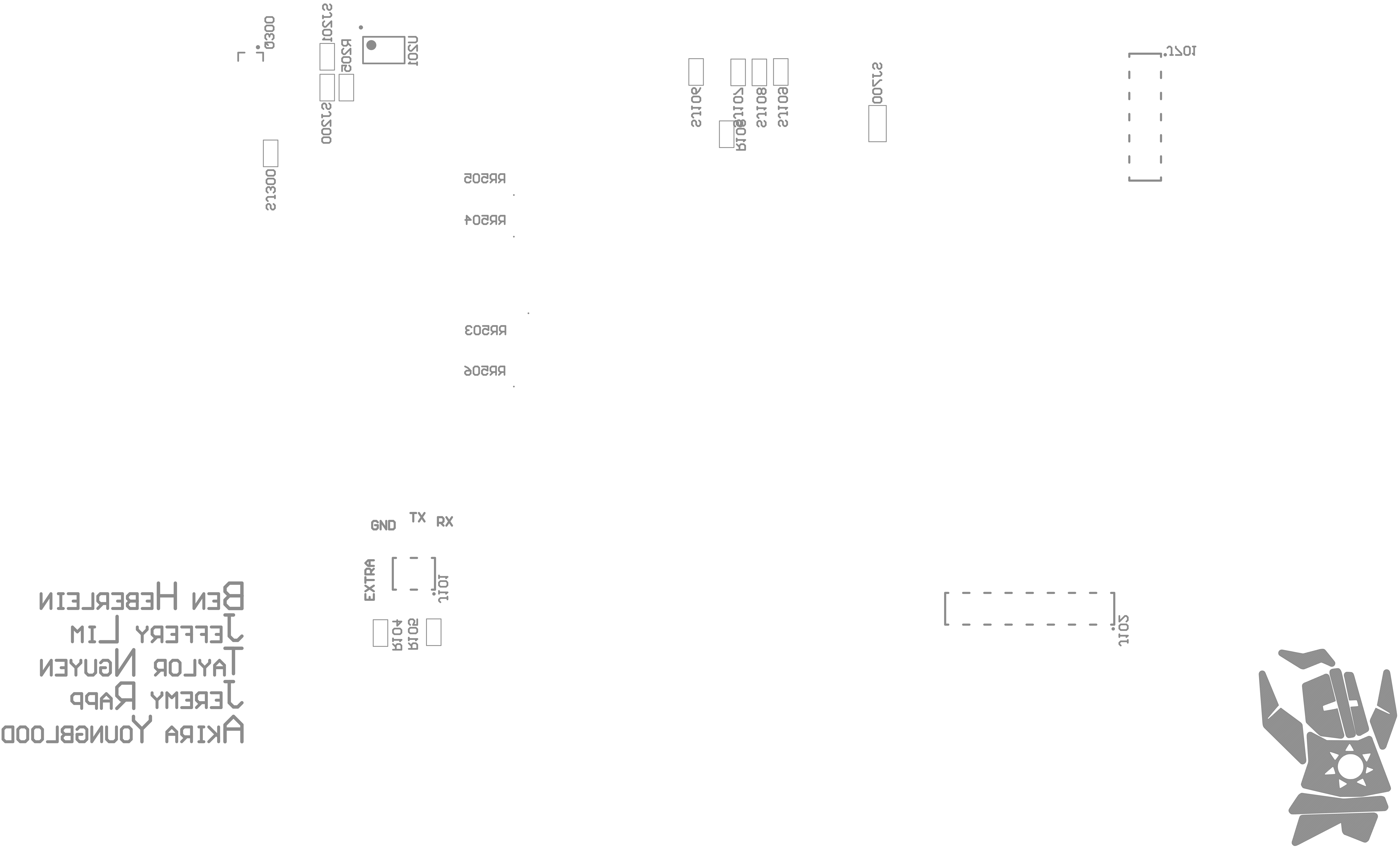











U201
R205
S1201
S1200
D300
S1300
RR505
RR504
RR503
RR506
S1106
S1108
S1109
R108
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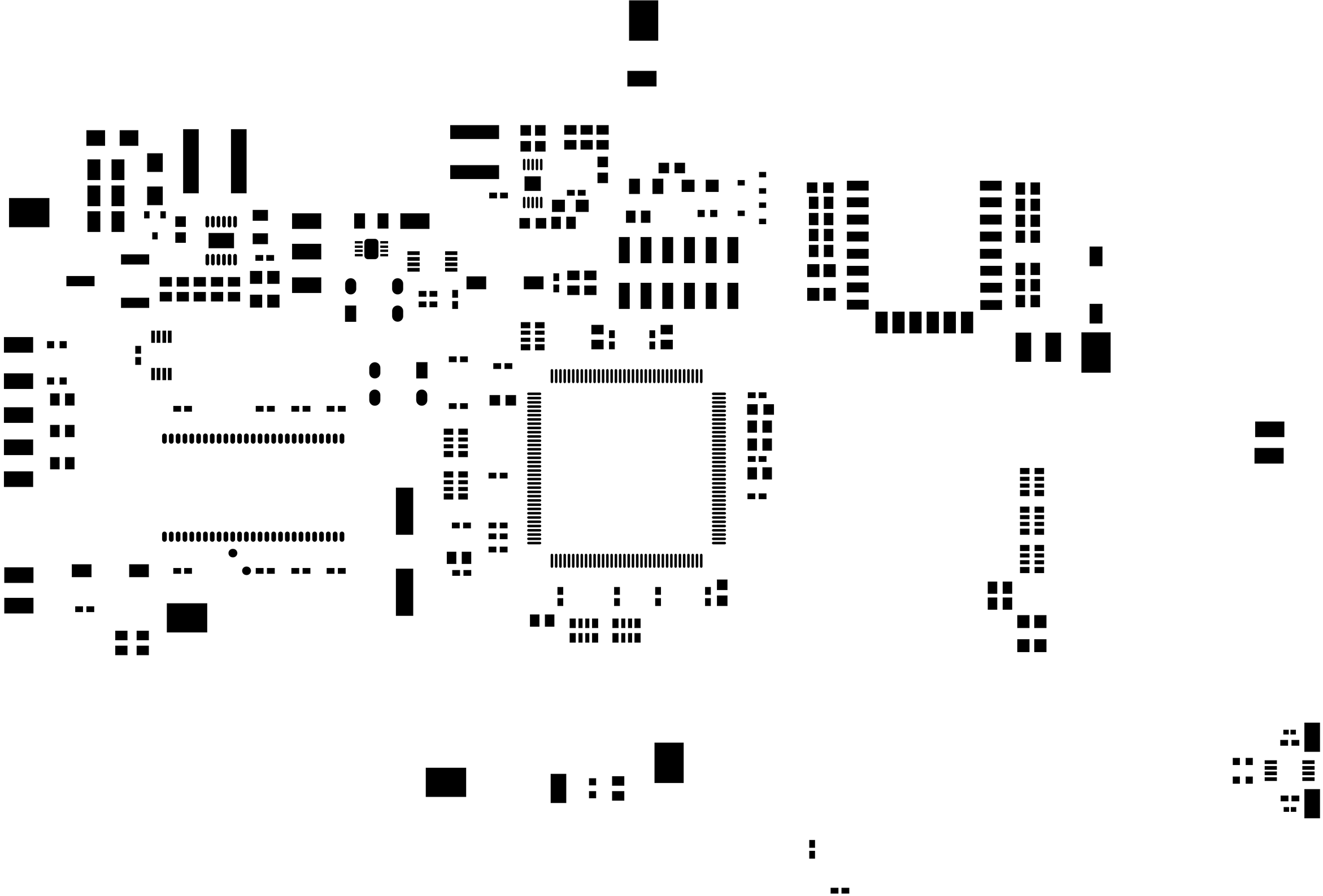
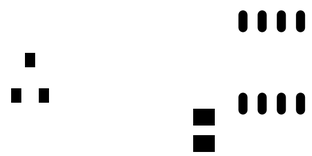
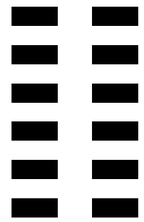
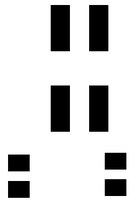
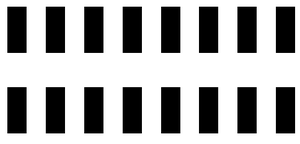
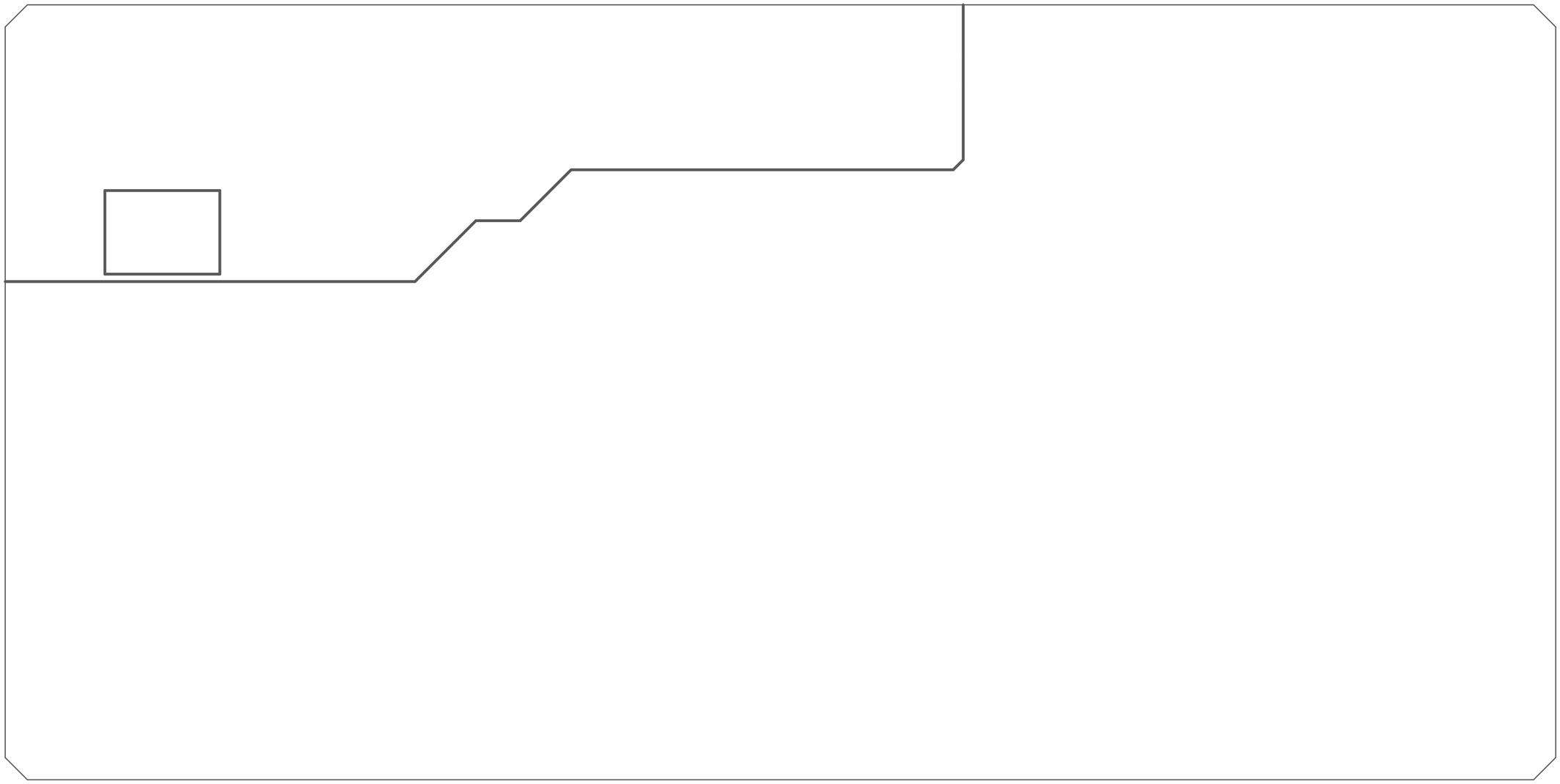




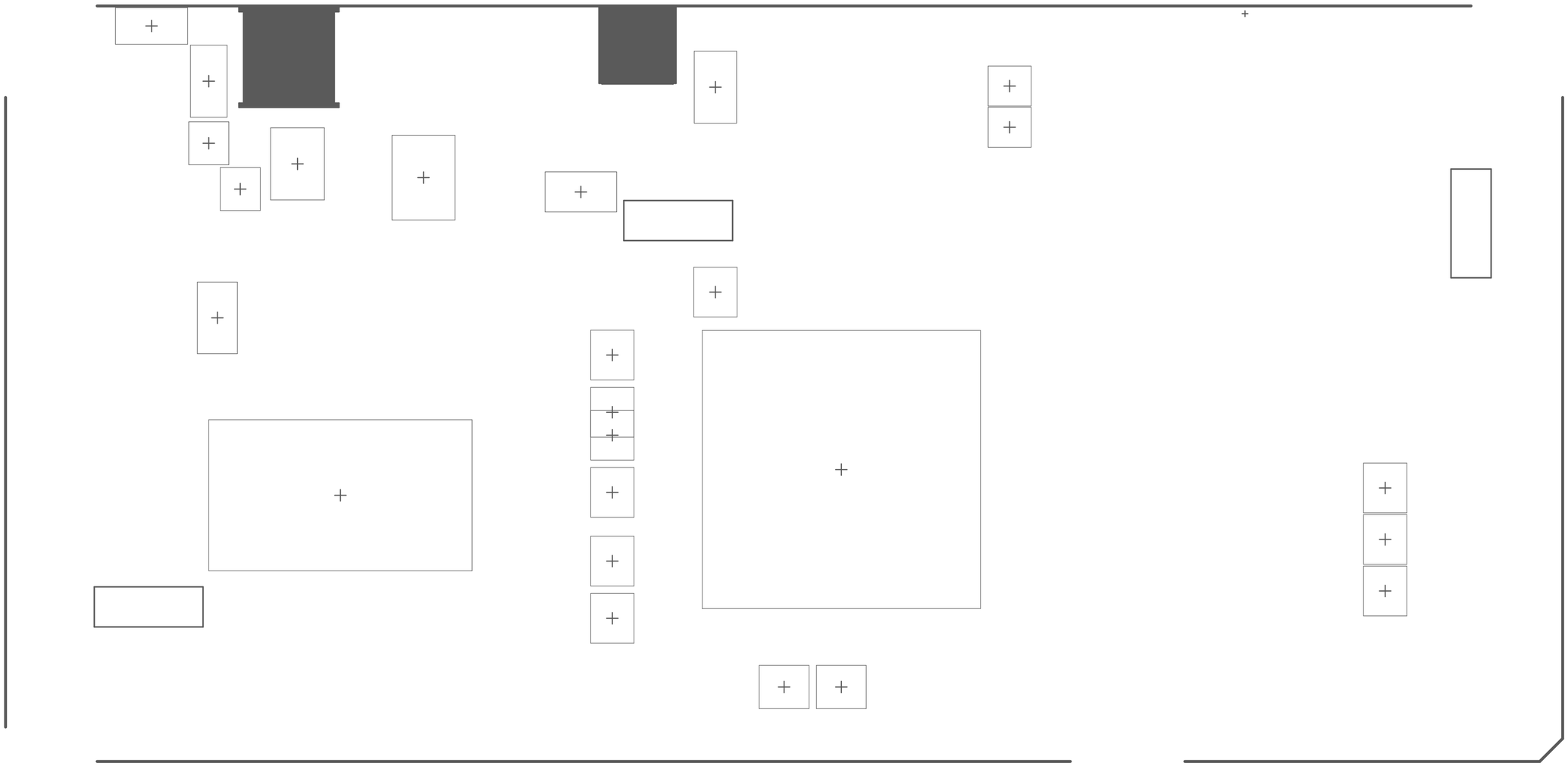








ANTENNA AREA
CUTOUT POLYGON



SOLENS

ANTENNA AREA
CUTOUT POLYGON